

Server S51A-1U



OVERVIEW

Siselectron S51A-1U is a general purpose rackmount server designed for optimal performance and power efficiency. It is based on the dual Intel® Xeon® processor E5-2600 w3, w4 product family and features up to 1.5 TB memory capacity in a 1U chassis.

BENEFITS

Greener and More Powerful

Powered by the Intel® Xeon® processor E5-2600 w3, w4 product family and DDR4 memory technology, the S51A-1U allows owners to upgrade computing performance without overextending power consumption. With an enhanced thermal design, the server can operate under ambient temperatures as high as 40°C. This allows owners to save unnecessary costs associated with datacenter cooling needs and to achieve higher data center infrastructure efficiency (DCIE) value.

Full-Featured Design for Demanding Virtualization Workload

With 24 dual in-line memory module (DIMM) slots, the S51A-1U oflers non-latency support to virtualization environments that require the maximum memory capacity. The S51A-1U also has two 2.5" PCIe Non-Volatile Memory Express (NVMe) SSDs on certain configuration options (with a 2.5" PtP backplane) to accelerate for today's demanding cloud storage and computing workload.

Flexible and Scalable I/O Options

The Siselectron S51A-1U provides flexible I/O scalability for today's diverse data center application requirements. It features OCP LAN mezzanine card solutions in addition to dual GbE or 10GbE (LAN on mother-boards (LoM). With various controller vendors and different speed and technology options, customers can choose from 1GbE to 56GbE bandwidth, copper or fiber-optic cabling, basic Ethernet function or FCoE and ISCI SAN connectivity. The on-board SAS controller offers multiple SAS mezzanine card options, with different RAID levels, and data transfer bandwidth, so customers can tailor the SAS controller for specific application needs.



CHARACTERISTICS

- Dual processor Intel Xeon E5-2600 v3,v4.
- L3 Cache: Up to 45MB
- Two GbE or 10G BASE-T RJ 45 port
- Option for 10G fiber-optic ports.
- Redundant Power Supply.
- 24 memory slots Up to 768GB RDIMM or 1536GB LRDIMM.
- Greener and More Powerful.
- Chipset Intel C610
- Storage hot-plug 2.5"
- Expansion slots
- Operating temperature: 5°C to 40°C (41°F to



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FEATURING

Processor

- Processor Type: Intel® Xeon® processor E5-2600 v3, v4 product family
- Max. TDP Support: 135W (145W with limited conditions)
- Number of Processors: 2
- Internal Interconnect: 6.4 / 8.0 / 9.6 GT/s
- L3 Cache: Up to 45MB

Chipset Intel® C610

Memory

- Total Slots: 24
- Capacity: Up to 768GB RDIMM Up to 1536GB LRDIMM
- Memory Type: 2133/2400 MHz DDR4 RDIMM/ LRDIMM
- Memory Size:
 32GB, 16GB, 8GB RDIMM
 64GB, 32GB LRDIMM

Network Controller

LOM:

- Option 1: Intel® I350 dual-port 1 GbE Dedicated 1 GbE management port
- Option 2: Intel® X540 dual-port 10GbE BASE-T Dedicated 1 GbE management port

Storage Controller

 Onboard: Support (2) SATADOM

Onboard Storage

• Intel® 610: (10) SATA 6Gb/s ports SATA RAID 0, 1, 10

Video

Integrated AST2400 with 8MB DDR3 video memory

Rear I/O

- (2) USB 3.0 ports
- (1) VGA port
- (1) RS232 serial Port
- (2) 1 GbE or 10G BASE-T RJ45 port
- (1) GbE RJ45 management port
- (1) ID LED
- (1) System LED

TPM

•Yes (With TPM 1.2/2.0 option)

Form Factor

•1U Rack Mount

Dimensions

- W x H x D (inch]: 17.244 x 1.7 x 29.21
- W x H x D (mm]: 438 x 43.2 x 742

Storage

- Option 1: (10) 2.5" hot-plug (including (2) optional 2.5" NVMe PCle SSD)
- Option 2: (10) 2.5" hot-plug (require additional LSI SAS/ MegaRAID card to connect to the expander backplane)
- Option 3:
 (4) 3.5" hot-plug, (2) 2.5" fixed SSD

Expansion Slot

- Option 1 (default):
 - (1) PCIe Gen3 x8 SAS mezzanine slot
 - (1) PCle Gen3 x16 FHHL
 - (1) PCle Gen3 x8 OCP LAN mezzanine slot
- Option 2:
 - (1) PCle Gen3 x16 LP MD-2
 - (1) PCIe Gen3 x16 FHHL
 - (1) PCIe Gen3 x8 OCP LAN mezzanine slot

Front I/O

- 2.5" SKU: None
- 3.5" SKU: (2) USB 2.0 ports

Power Supply

- 1200W AC, Redundant, 86 mm (Platinum)
- 800W AC, Redundant, 86 mm (Platinum)
- 750W AC, Redundant, 86 mm (Gold)
- 500W AC, Redundant, 86 mm (Platinum)
- 470W AC, Redundant, 86 mm (Gold)

Fan

• (6) dual rotor fans (11+1 redundant)

System Management

- IPMI v2.0 Compliant, onboard "KVM over IP"
- DataCenter Manager(QDCM) (optional) support

Operating Environment

- Operating temperature:
 5°C to 40°C (41°F to 104°F)
- Non-operating temperature:
 -40°C to 65°C (-40°F to 149°F)
- Operating relative humidity: 20% to 85%RH.
- Non-operating relative humidity: 10% to 90%RH

Weight (Max.Configuration)

- 19.97 (kg)
- 44.03 (lbs)



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